

Customer No.: 31561
Application No.: 10/709,125
Docket NO.: 11808-US-PA

REMARKS

In response to the Office Action, mailed on June 30, 2005, a complete listing of all of the claims is presented herewith. Applicant would like to elect Group I, claims 1-12, drawn to a semiconductor product, classified in class 257, subclass 314+. Please cancel the following two groups without waiver, prejudice or disclaimer:

1. Group II, claims 13-20, drawn to a method of making a product, classified in class 438, subclass 257+;
2. Group III, claims 21-29, drawn to a method of using a semiconductor device, classified in class 365, subclass 185.01+.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date:

July 27, 2005

Respectfully submitted,



Belinda Lee

Registration No.: 46,863

Jianq Chyun Intellectual Property Office
7th Floor-1, No. 100
Roosevelt Road, Section 2
Taipei, 100
Taiwan
Tel: 011-886-2-2369-2800
Fax: 011-886-2-2369-7233
Email: belinda@jicpgroup.com.tw
Usa@jicpgroup.com.tw